

Description

The AON6354 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

SSS G SSS G Pin 1

DFN5X6-8L

General Features

V_{DS} = 30V I_D =150A

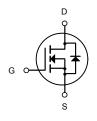
 $R_{DS(ON)} < 2.4 m\Omega V_{GS} = 10V$

Application

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
AON6354	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units		
V _{DS}	Drain-Source Voltage	Drain-Source Voltage 30			
Vgs	Gate-Source Voltage	±20	V		
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	150	А		
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	80	А		
Ірм	Pulsed Drain Current ²	160	А		
EAS	Single Pulse Avalanche Energy ³	180	mJ		
las	Avalanche Current	60	Α		
P _D @T _C =25°C	Total Power Dissipation ⁴	187	W		
Тѕтѕ	Storage Temperature Range	-55 to 150	°C		
TJ	Operating Junction Temperature Range	-55 to 150	°C		
ReJA	Thermal Resistance Junction-Ambient ¹	62	°C/W		
ReJC Thermal Resistance Junction-Case ¹		1.1	°C/W		



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =1mA		0.014		V/°C	
Descour	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =30A	2 2.4		2.4	0	
R _{DS(ON)}	Static Drain-Source On-Resistance-	V _{GS} =4.5V , I _D =15A		2.5	3.2	mΩ	
$V_{GS(th)}$	Gate Threshold Voltage	\/=\/	1.2		2.5	٧	
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-4		mV/°C	
1	Drain Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	- uA	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55°C			5		
Igss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA	
gfs	Forward Transconductance V _{DS} =5V , I _D =30A			50		S	
Rg	Gate Resistance	Gate Resistance V _{DS} =0V , V _{GS} =0V , f=1MHz		1.7		Ω	
Q_g	Total Gate Charge (4.5V)			56.9			
Q_{gs}	Gate-Source Charge			13.8		nC	
Q_{gd}	Gate-Drain Charge			23.5			
$T_{d(on)}$	Turn-On Delay Time			20.1			
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω ,		6.3		no	
$T_{d(off)}$	Turn-Off Delay Time	I _D =1A		124.6		ns	
T _f	Fall Time			15.8			
Ciss	Input Capacitance			4345			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		340		pF	
Crss	Reverse Transfer Capacitance			225			

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}	V _G =V _D =0V , Force Current			150	Α
V_{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =1A , T_{J} =25 $^{\circ}$ C			1.2	V

Note

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =60A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.
- 6. Package limitation current is 85A.

Typical Characteristics

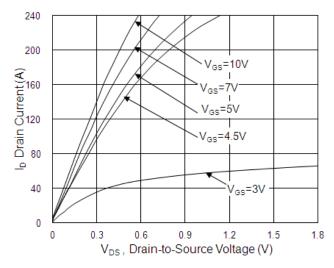


Fig.1 Typical Output Characteristics

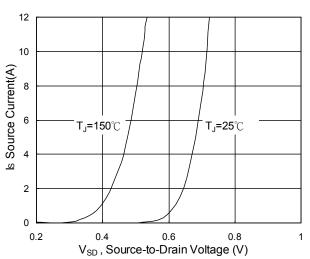


Fig.3 Forward Characteristics of Reverse

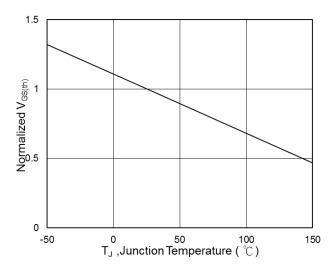


Fig.5 Normalized $V_{\text{GS(th)}}$ v.s T_{J}

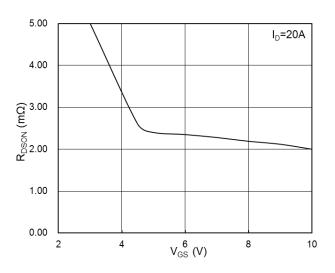


Fig.2 On-Resistance v.s Gate-Source

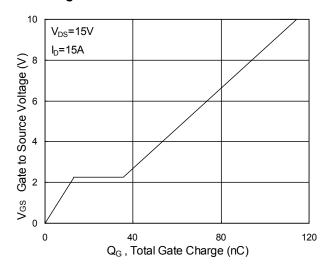


Fig.4 Gate-Charge Characteristics

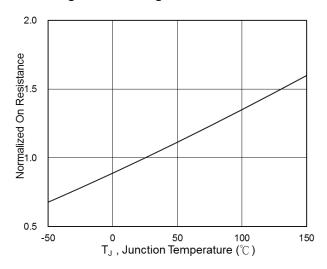
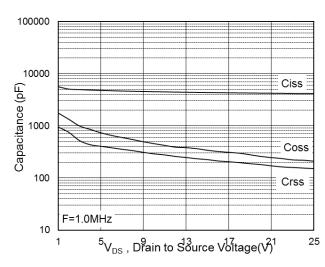


Fig.6 Normalized R_{DSON} v.s T_J



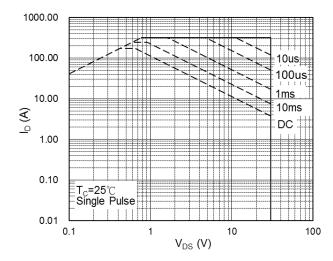


Fig.7 Capacitance

Fig.8 Safe Operating Area

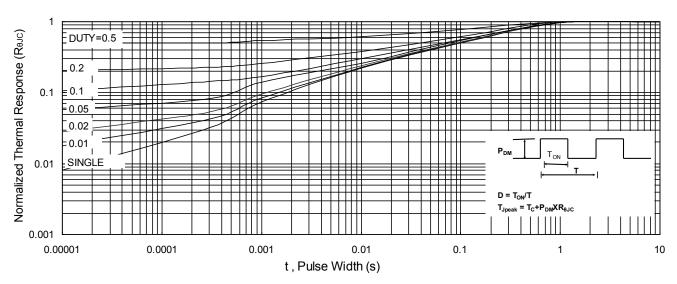
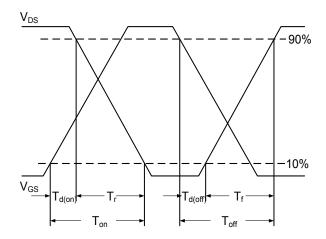


Fig.9 Normalized Maximum Transient Thermal Impedance





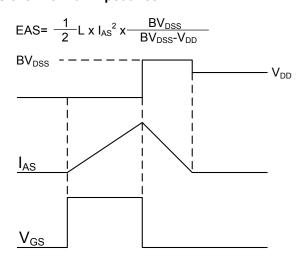
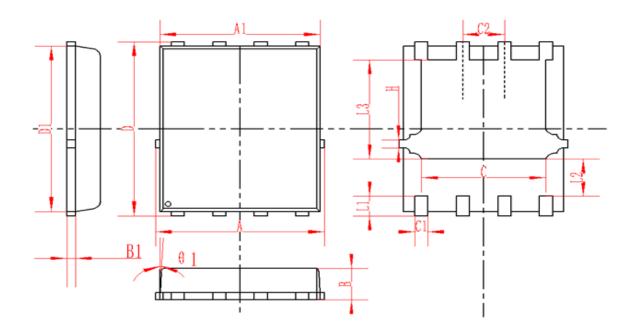


Fig.11 Unclamped Inductive Switching Waveform

DFN5X6-8L Package Information



SYMBOL		MM			INCH			
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX		
Α	5.3	5.5	5.7	0.208	0.216	0.224		
A1	5.1	5.2	5.3	0.2	0.204	0.209		
D	5.98	6	6.02	0.235	0.236	0.237		
D1	5.85	6.05	6.25	0.23	0.238	0.246		
В	0.85	0.95	1.05	0.033	0.037	0.041		
B1	0.254REF			0.010REF				
С	3.95	4	4.05	0.156	0.157	0.159		
C1	0.35	0.4	0.45	0.014	0.016	0.018		
C2	1.27TYP			0.5TYP				
θ1	8°	10°	12°	8°	10°	12°		
L1	0.63	0.64	0.65	0.025	0.025	0.026		
L2	1.2	1.3	1.4	0.047	0.051	0.055		
L3	3.415	3.42	3.425	0.134	0.135	0.135		
Н	0.24	0.25	0.26	0.009	0.010	0.010		

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